

# Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0.40mil	3.5
4		Top Layer	Copper	1.40mil	
5		Dielectric 1	FR-4	12.60mil	4.8
6		Bottom Layer	Copper	1.40mil	
7		Bottom Solder	Solder Resist	0.40mil	3.5
8		Bottom Overlay			
9		Bottom Paste			
	Height : 16.20mil				